

LD MVSG

Mini TOPLED®

Small size high-flux LED for slim designs



Applications

- Cluster, Button Backlighting
- Electronic Equipment
- Transportation, Plane, Ship
- White Goods

Features:

- Package: white SMD package, colorless clear silicone resin
- Chip technology: UX:3
- Typ. Radiation: 120° (Lambertian emitter)
- Color: $\lambda_{\text{dom}} = 460 \text{ nm}$ (● deep blue)
- Corrosion Robustness Class: 3B
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)

Ordering Information

Type	Radiant Intensity ¹⁾ $I_F = 20 \text{ mA}$ I_e	Ordering Code
LD MVSG-JGLH-46-1	4.5 ... 15.0 mW/sr	Q65111A2195

Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	T_{op}	min.	-40 °C
		max.	110 °C
Storage Temperature	T_{stg}	min.	-40 °C
		max.	110 °C
Junction Temperature	T_j	max.	125 °C
Forward current	I_F	min.	3 mA
$T_s = 25\text{ °C}$		max.	30 mA
Surge Current	I_{FS}	max.	300 mA
$t \leq 10\text{ }\mu\text{s}$; $D = 0.005$; $T_s = 25\text{ °C}$			
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	V_{ESD}		8 kV
Reverse current ²⁾	I_R	max.	200 mA

Characteristics

$I_F = 20 \text{ mA}$; $T_S = 25 \text{ °C}$

Parameter	Symbol		Values
Peak Wavelength ³⁾	λ_{peak}	typ.	455 nm
Dominant Wavelength ³⁾	λ_{dom}	min.	453 nm
$I_F = 20 \text{ mA}$		typ.	460 nm
		max.	465 nm
Spectral Bandwidth at 50% $I_{\text{rel,max}}$	$\Delta\lambda$	typ.	20 nm
Viewing angle at 50 % I_V	2ϕ	typ.	120 °
Forward Voltage ⁴⁾	V_F	min.	2.70 V
$I_F = 20 \text{ mA}$		typ.	3.05 V
		max.	3.40 V
Reverse voltage (ESD device)	$V_{\text{R ESD}}$	min.	45 V
Reverse voltage ²⁾	V_R	max.	1.2 V
$I_R = 20 \text{ mA}$			
Real thermal resistance junction/ambient ^{5), 6)}	$R_{\text{thJA real}}$	max.	430 K / W
Real thermal resistance junction/solderpoint ⁵⁾	$R_{\text{thJS real}}$	max.	130 K / W

Brightness Groups

Group	Radiant Intensity ¹⁾ $I_F = 20 \text{ mA}$ min. I_e	Radiant Intensity ¹⁾ $I_F = 20 \text{ mA}$ max. I_e
JG	4.5 mW/sr	5.2 mW/sr
JH	5.2 mW/sr	6.1 mW/sr
JI	6.1 mW/sr	7.1 mW/sr
KG	7.1 mW/sr	8.2 mW/sr
KH	8.2 mW/sr	9.7 mW/sr
KI	9.7 mW/sr	11.2 mW/sr
LG	11.2 mW/sr	13.0 mW/sr
LH	13.0 mW/sr	15.0 mW/sr

Forward Voltage Groups

Group	Forward Voltage ⁴⁾ $I_F = 20 \text{ mA}$ min. V_F	Forward Voltage ⁴⁾ $I_F = 20 \text{ mA}$ max. V_F
Z4	2.70 V	2.90 V
44	2.90 V	3.10 V
86	3.10 V	3.40 V

Wavelength Groups

Group	Dominant Wavelength ³⁾ $I_F = 20 \text{ mA}$ min. λ_{dom}	Dominant Wavelength ³⁾ $I_F = 20 \text{ mA}$ max. λ_{dom}
4	453 nm	457 nm
5	457 nm	461 nm
6	461 nm	465 nm

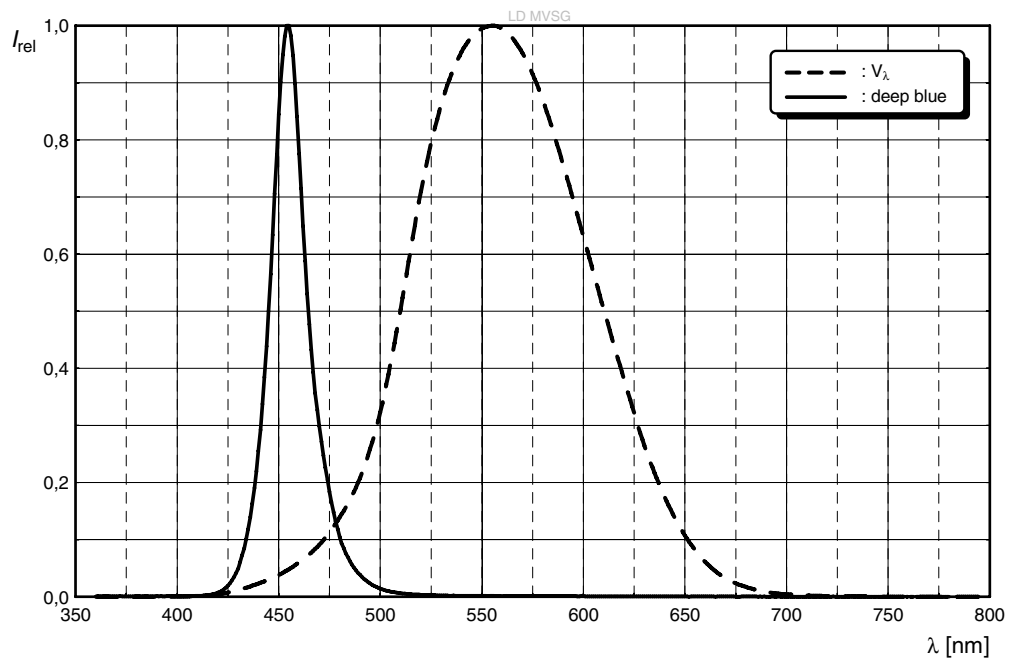
Group Name on Label

Example: JG-4-44

Brightness	Wavelength	Forward Voltage
JG	4	44

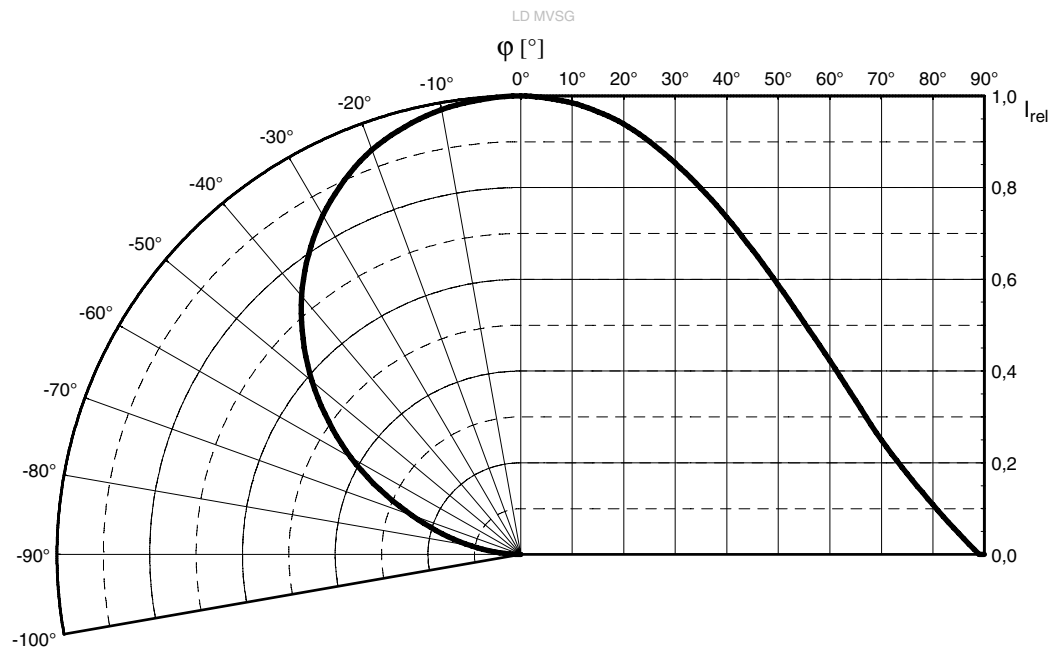
Relative Spectral Emission ⁷⁾

$I_{\text{rel}} = f(\lambda); I_F = 20 \text{ mA}; T_S = 25 \text{ °C}$



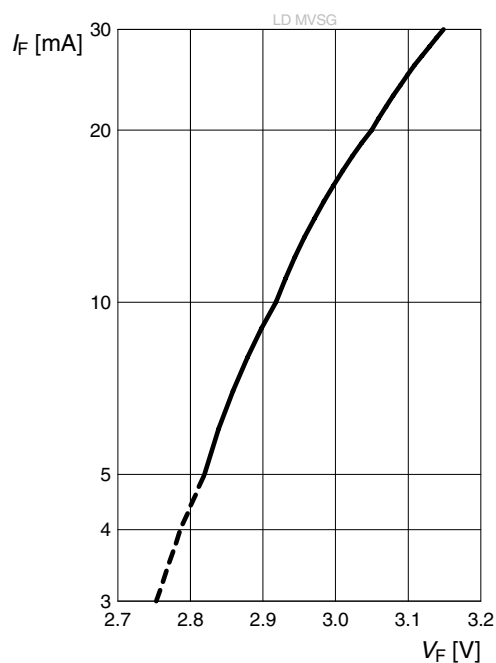
Radiation Characteristics ⁷⁾

$I_{\text{rel}} = f(\phi); T_S = 25 \text{ °C}$

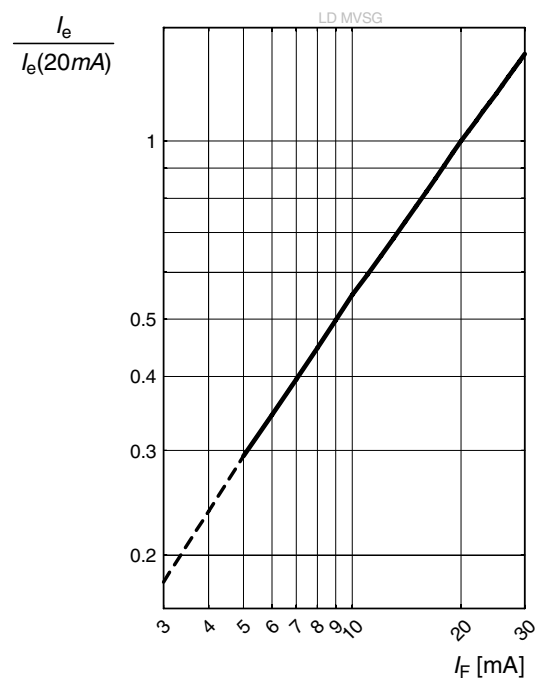


Forward current ⁷⁾

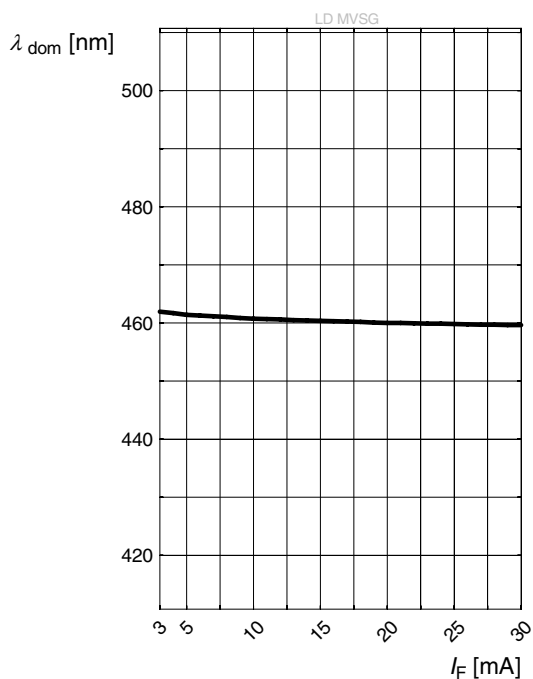
$$I_F = f(V_F); T_S = 25\text{ °C}$$

**Relative Radiant Intensity** ^{7), 8)}

$$I_E/I_E(20\text{ mA}) = f(I_F); T_S = 25\text{ °C}$$

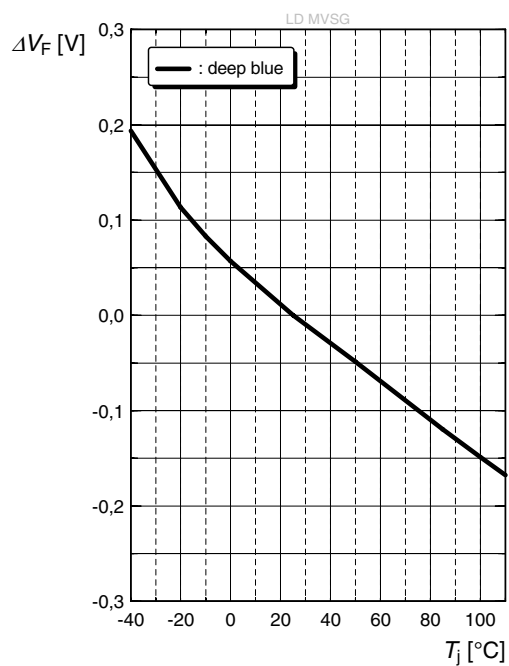
**Dominant Wavelength** ⁷⁾

$$\lambda_{\text{dom}} = f(I_F); T_S = 25\text{ °C}$$

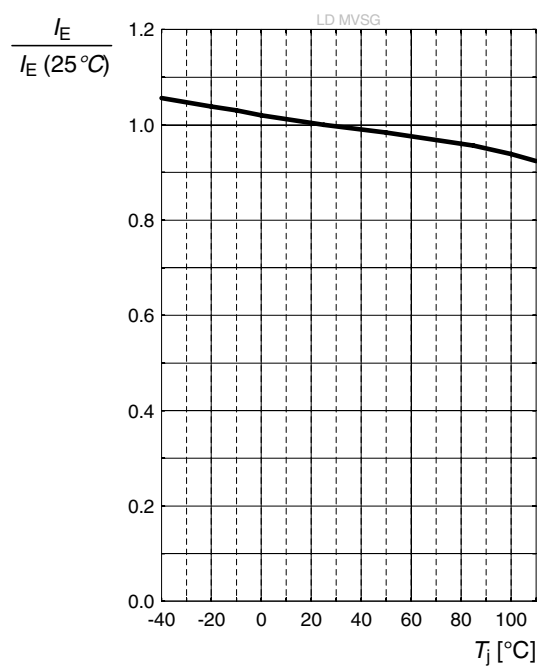


Forward Voltage ⁷⁾

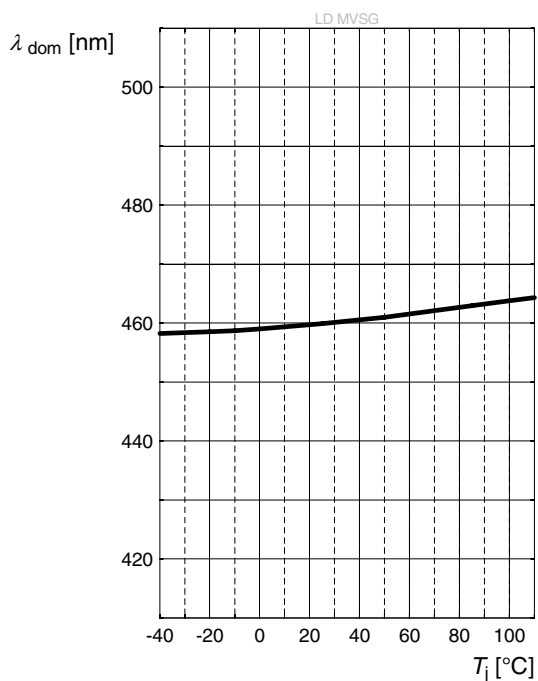
$$\Delta V_F = V_F - V_F(25\text{ °C}) = f(T_j); I_F = 20\text{ mA}$$

**Relative Radiant Intensity** ⁷⁾

$$I_E/I_E(25\text{ °C}) = f(T_j); I_F = 20\text{ mA}$$

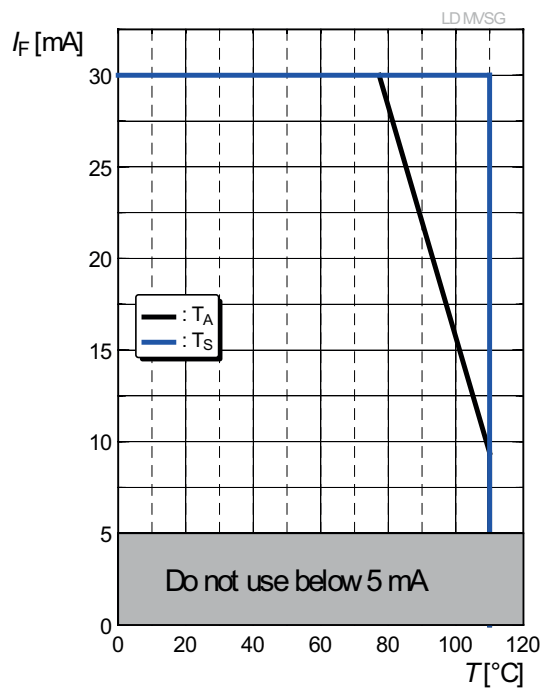
**Dominant Wavelength** ⁷⁾

$$\lambda_{\text{dom}} = f(T_j); I_F = 20\text{ mA}$$



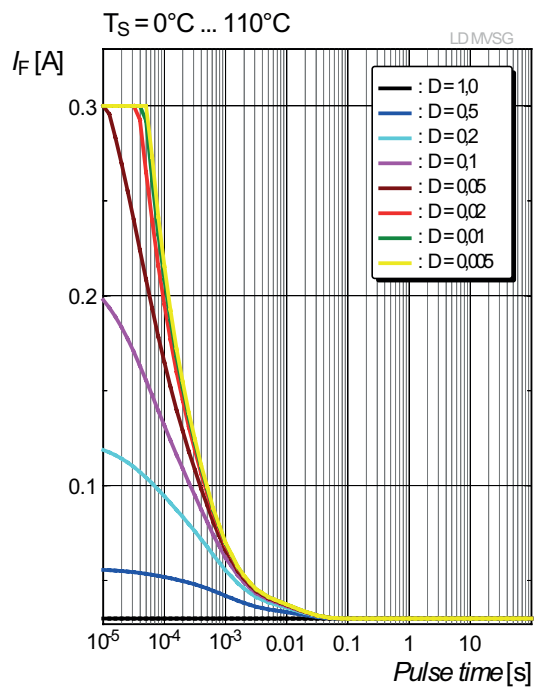
Max. Permissible Forward Current

$$I_F = f(T)$$

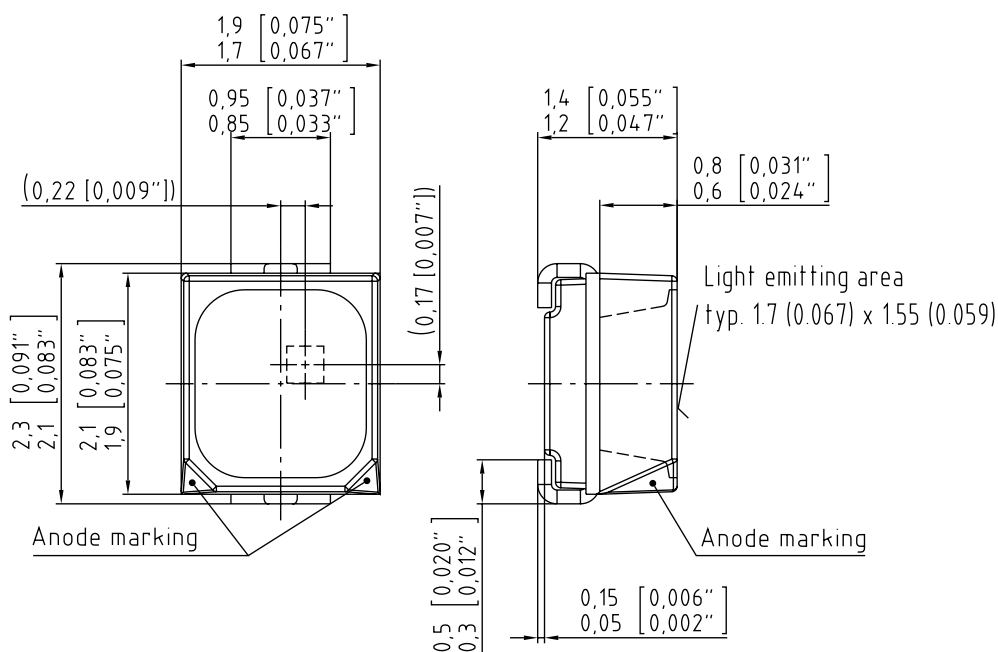


Permissible Pulse Handling Capability

$$I_F = f(t_p); D: \text{Duty cycle}$$



Dimensional Drawing ⁹⁾



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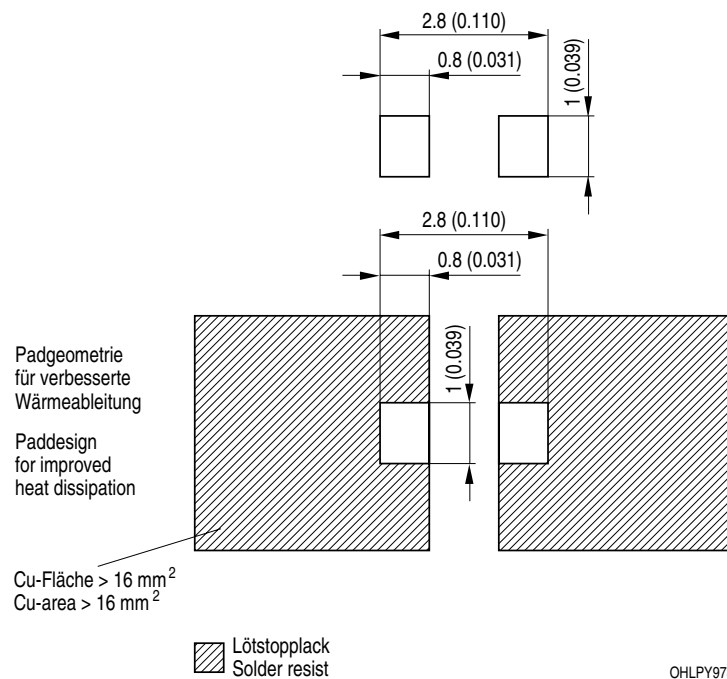
Approximate Weight: 9.0 mg

Package marking: Anode

Corrosion test: Class: 3B
Test condition: 40°C / 90 % RH / 15 ppm H₂S / 14 days (stricter then IEC 60068-2-43)

ESD advice: The device is protected by ESD device which is connected in parallel to the Chip.

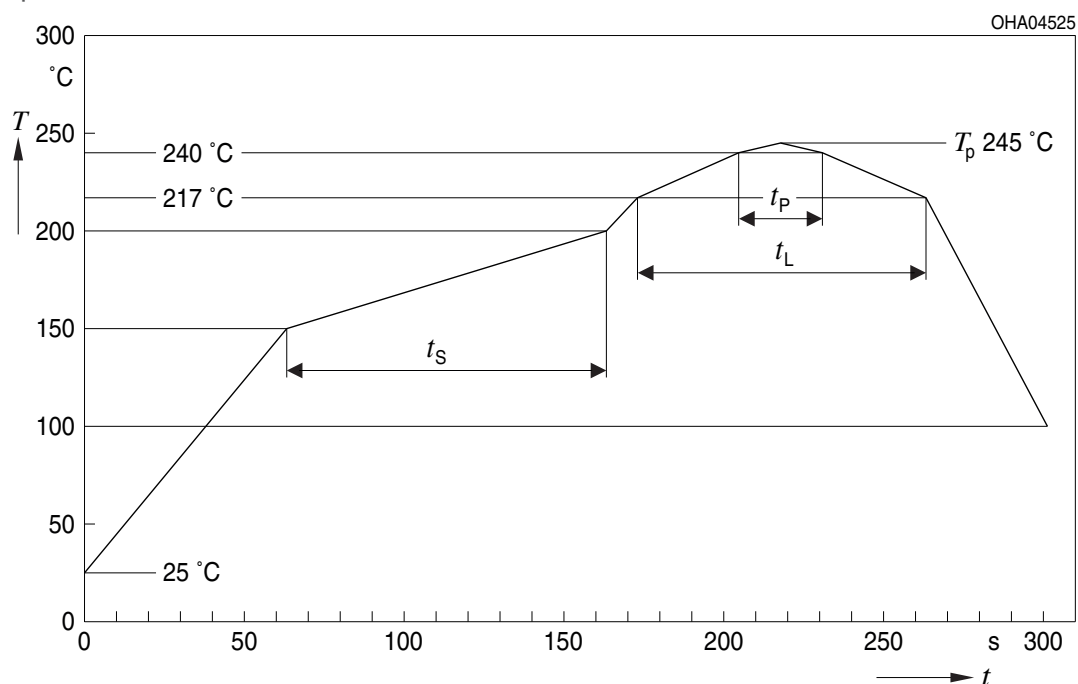
Recommended Solder Pad ⁹⁾



For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere.

Reflow Soldering Profile

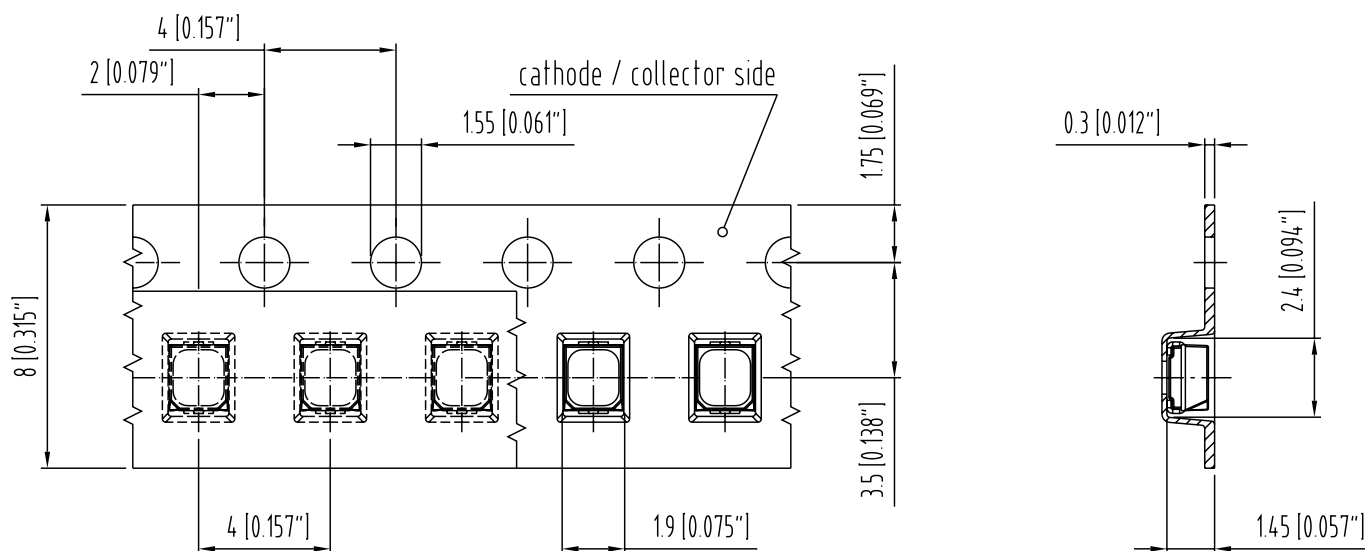
Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up rate to peak*) T_{Smax} to T_p			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_p		245	260	°C
Time within 5 °C of the specified peak temperature $T_p - 5$ K	t_p	10	20	30	s
Ramp-down rate* T_p to 100 °C			3	6	K/s
Time 25 °C to T_p				480	s

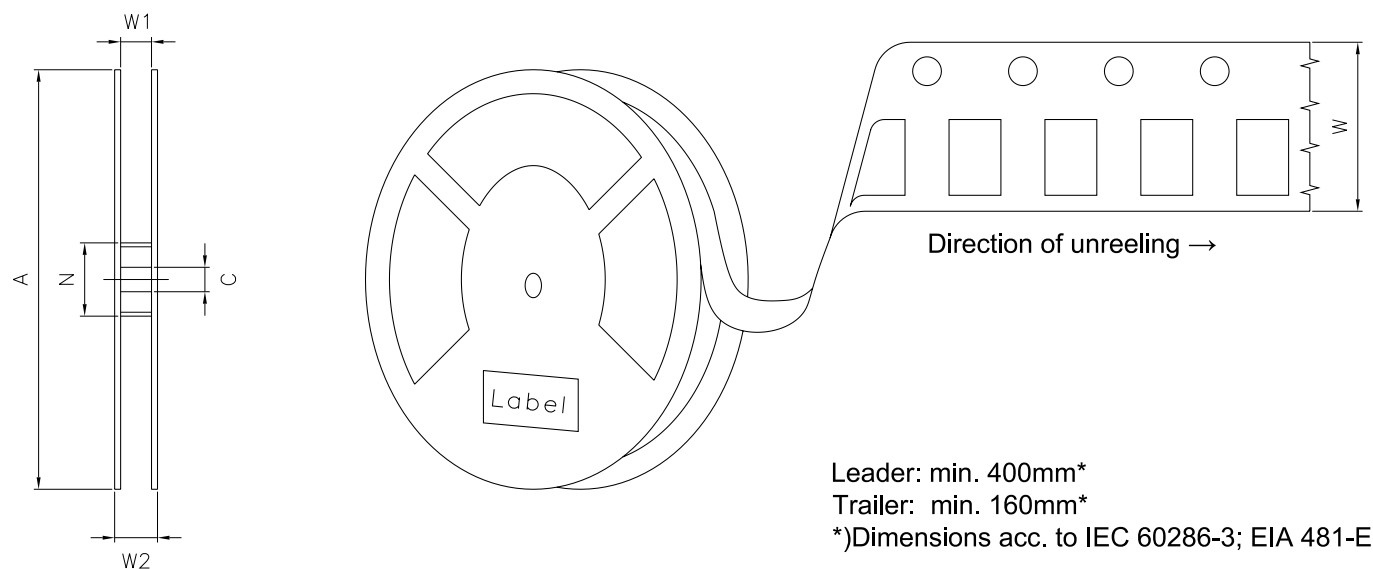
All temperatures refer to the center of the package, measured on the top of the component

* slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

Taping ⁹⁾

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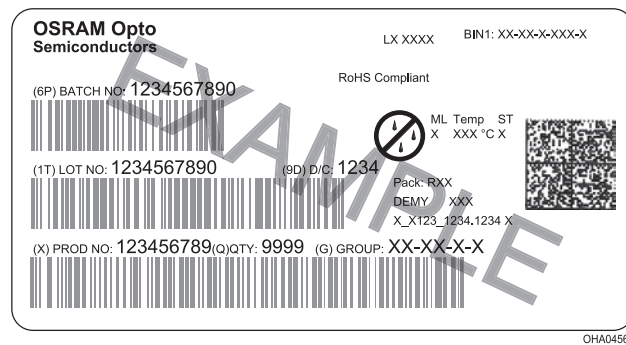
Tape and Reel ¹⁰⁾



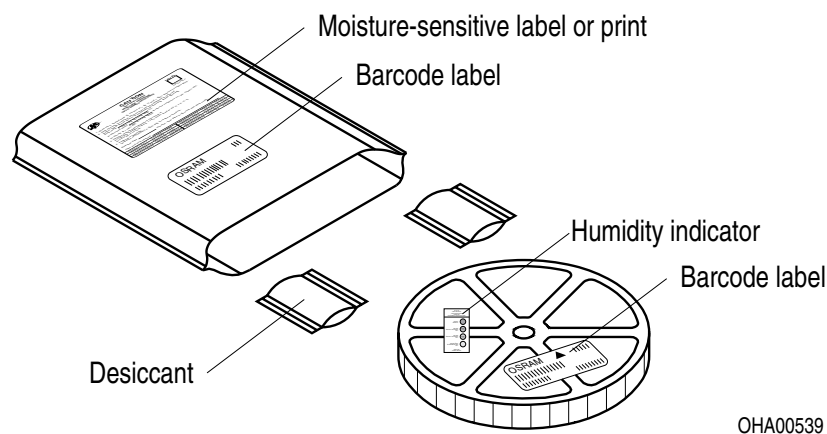
Reel dimensions [mm]

A	W	N _{min}	W ₁	W _{2 max}	Pieces per PU
180 mm	8 + 0.3 / - 0.1	60	8.4 + 2	14.4	3000

Barcode-Product-Label (BPL)



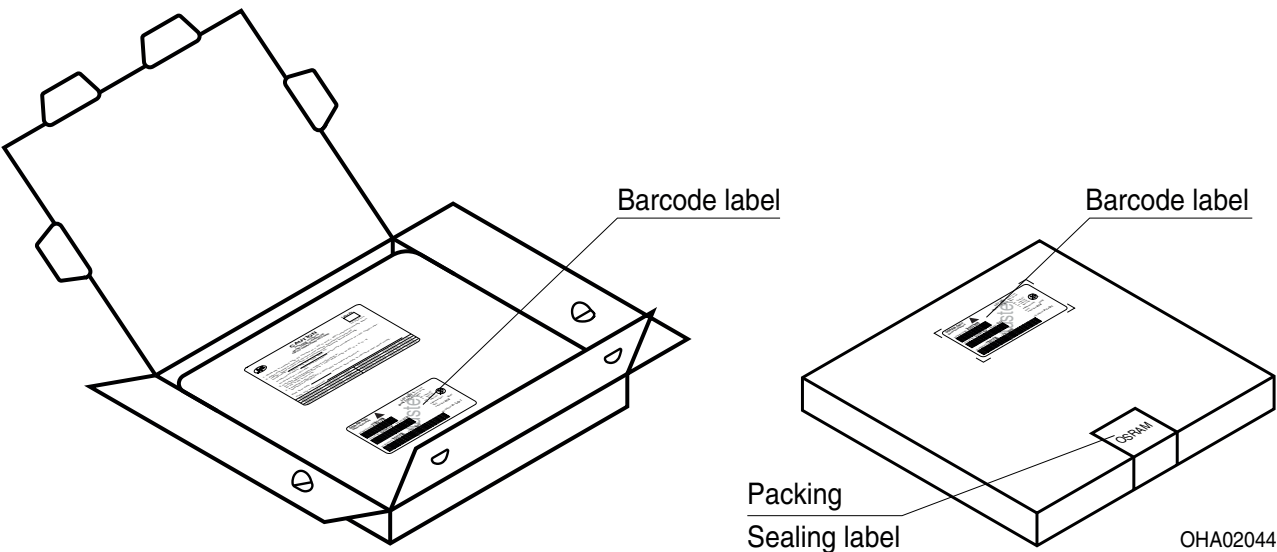
Dry Packing Process and Materials ⁹⁾



OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

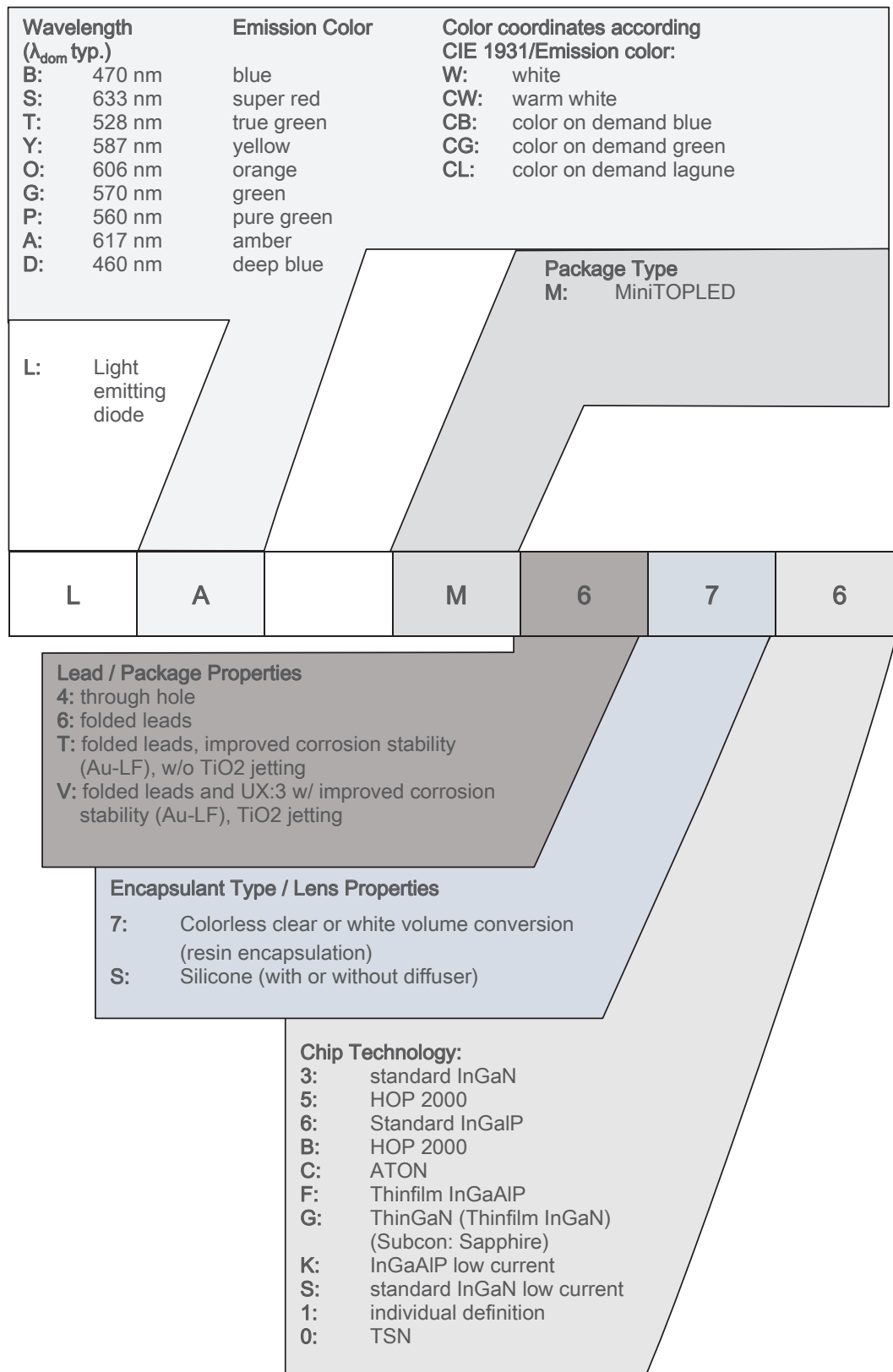
Transportation Packing and Materials ⁹⁾



Dimensions of transportation box in mm

Width	Length	Height
200 ± 5 mm	195 ± 5 mm	30 ± 5 mm

Type Designation System



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related informations please visit www.osram-os.com/appnotes

Disclaimer

Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

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Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office.

By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

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OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

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Glossary

- 1) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (acc. to GUM with a coverage factor of $k = 3$).
- 2) **Reverse Operation:** Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- 3) **Wavelength:** The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of $\pm 0.5\text{ nm}$ and an expanded uncertainty of $\pm 1\text{ nm}$ (acc. to GUM with a coverage factor of $k = 3$).
- 4) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of $\pm 0.05\text{ V}$ and an expanded uncertainty of $\pm 0.1\text{ V}$ (acc. to GUM with a coverage factor of $k = 3$).
- 5) **Thermal Resistance:** $R_{th\text{ max}}$ is based on statistic values (6σ).
- 6) **Thermal Resistance:** R_{thJA} results from mounting on PC board FR 4 (pad size 16 mm^2 per pad)
- 7) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 8) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 9) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.
- 10) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

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EU RoHS and China RoHS compliant product



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